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## 32-Channel Serial to Parallel Converter With High Voltage Push-Pull Outputs

## Features

- Processed with HVCMOS ${ }^{\circledR}$ technology
- Low power level shifting
- SOURCE/SINK current minimum 20 mA
- Shift register speed 8.0 MHz
- Latched data outputs
- CMOS compatible inputs
- Forward and reverse shifting options
- Diode to VPP allows efficient power recovery


## General Description

The HV5408B is a low voltage serial to high voltage parallel converter with push-pull outputs. This device has been designed for use as a driver for AC-electroluminescent displays. It can also be used in any application requiring multiple output high voltage current sourcing and sinking capabilities, such as driving plasma panels, vacuum fluorescent, or large matrix LCD displays.

The HV5408B consists of a 32-bit shift register, 32 latches, and control logic to enable outputs. Q1 is connected to the first stage of the shift register through the Output Enable logic. Data is shifted through the shift register on the low to high transition of the clock. When viewed from the top of the package, the HV5408B shifts in the counter-clockwise direction. A data output buffer is provided for cascading devices. This output reflects the current status of the last bit of the shift register (32). Operation of the shift register is not affected by the $\overline{\mathrm{LE}}$ (latch enable) or the OE (output enable) inputs. Transfer of data from the shift register to the latch occurs when the $\overline{\mathrm{LE}}$ input is high. The data in the latch is retained when $\overline{\mathrm{LE}}$ is low.

## Typical Application Circuit



Ordering Information

| Device | Package Options |  |  |
| :---: | :---: | :---: | :---: |
|  | 44-Lead Quad Cerpac .650x.650in body .190in height (max) .050in pitch | 44-Lead PQFP <br> 10.00x10.00mm body <br> 2.35 mm height (max) <br> 0.80 mm pitch | 44-Lead PLCC <br> .653x.653in body .180in height (max) .050in pitch |
| HV5408B | HV5408DJ-B* | HV5408PG-B-G | HV5408PJ-B-G |


-G indicates package is RoHS compliant ('Green').

* Hi-Rel process flow available.


## Pin Configurations

## Absolute Maximum Ratings

| Parameter | Value |
| :--- | ---: |
| Supply voltage, $\mathrm{V}_{\mathrm{DD}}$ | -0.5 V to +16 V |
| Supply voltage, $\mathrm{V}_{\mathrm{PP}}$ | -0.5 V to +90 V |
| Logic input levels | -0.5 V to $\mathrm{V}_{\mathrm{DD}}+0.5 \mathrm{~V}$ |
| Ground current ${ }^{1}$ | 1.5 A |
| Continuous total power dissipation <br>  <br> Plastic <br> Ceramic | 1200 mW |
| Operating temperature range <br> Plastic <br> Ceramic | 1500 mW |
| Storage temperature range | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

## Notes:

1. Duty cycle is limited by the total power dissipated in the package.
2. For operation above $25^{\circ} \mathrm{C}$ ambient derate linearly to maximum operating temperature at $20 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ for plastic and at $15 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ for ceramic.


## Product Marking



Bottom Marking


44-Lead Quad Cerpac (DJ)

Bottom Marking


YY = Year Sealed WW = Week Sealed L = Lot Number
C = Country of Origin*
A = Assembler ID*
$\qquad$ = "Green" Packaging
*May be part of top marking
44-Lead PQFP
(PG)

Top Marking


Bottom Marking

$Y Y=$ Year Sealed WW = Week Sealed $\mathrm{L}=$ Lot Number A = Assembler ID C = Country of Origin* __= "Green" Packaging "May be part of top marking

44-Lead PLCC
(PJ)

Packages may or may not include the following marks: Si or $\$$

Recommended Operating Conditions (over $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ for plastic and $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ for ceramic)

| Sym | Parameter | Min | Max | Units |
| :---: | :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{DD}}$ | Logic voltage supply | 10.8 | 13.2 | V |
| $\mathrm{~V}_{\mathrm{PP}}$ | High voltage supply | 8.0 | 80 | V |
| $\mathrm{~V}_{\mathrm{IH}}$ | Input high voltage | $\mathrm{V}_{\mathrm{DD}}-2.0$ | $\mathrm{~V}_{\mathrm{DD}}$ | V |
| $\mathrm{V}_{\mathrm{IL}}$ | Input low voltage | 0 | 2.0 | V |
| $\mathrm{f}_{\mathrm{CLK}}$ | Clock frequency | 0 | 8.0 | MHz |

## Power-Up Sequence

## Power-up sequence should be the following:

1. Connect ground
2. Apply $V_{D D}$
3. Set all inputs (Data, CLK, $\overline{L E}$, etc.) to a known state
4. Apply VPP
5. The $V_{P P}$ should not fall below $V_{D D}$ or float during operation.

Power-down sequence should be the reverse of the above.
Electrical Characteristics $\left(V_{P P}=60 V, V_{D O}=12 V, T_{A}=25^{\circ} C\right)$
DC Characteristics

| Sym | Parameter | Min | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{I}_{\text {PP }}$ | $\mathrm{V}_{\text {PP }}$ supply current | - | 0.5 | mA | HV ${ }_{\text {outputs }}$ high to low |
| $\mathrm{I}_{\text {DDQ }}$ | $\mathrm{I}_{\text {DD }}$ supply current (quiescent) | - | 100 | $\mu \mathrm{A}$ | All inputs $=V_{\text {DD }}$ or GND |
| $I_{\text {D }}$ | $\mathrm{I}_{\text {DD }}$ supply current (operating) | - | 15 | mA | $\mathrm{V}_{\mathrm{DD}}=\mathrm{V}_{\mathrm{DD}} \mathrm{max}, \mathrm{f}_{\text {CLK }}=8.0 \mathrm{MHz}$ |
| $\mathrm{V}_{\mathrm{OH}}$ (data) | Shift register output voltage | 10.5 | - | V | $\mathrm{I}_{0}=-100 \mu \mathrm{~A}$ |
| $\mathrm{V}_{\text {OL }}$ (data) | Shift register output voltage | - | 1.0 | V | $\mathrm{I}_{0}=100 \mu \mathrm{~A}$ |
| $\mathrm{I}_{\mathrm{H}}$ | Current leakage, any input | - | 1.0 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{DD}}$ |
| ILI | Current leakage, any input | - | -1.0 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {IN }}=0$ |
| $V_{\text {oc }}$ | HV output clamp diode voltage | - | -1.5 | V | $\mathrm{I}_{\mathrm{LL}}=-100 \mathrm{~mA}$ |
| $\mathrm{V}_{\mathrm{OH}}$ | HV output when sourcing | 52 | - | V | $\mathrm{I}_{\text {OH }}=-20 \mathrm{~mA},-40$ to $85^{\circ} \mathrm{C}$ |
| $\mathrm{V}_{\mathrm{oL}}$ | HV output when sinking | - | 8.0 | V | $\mathrm{I}_{\mathrm{OL}}=20 \mathrm{~mA},-40$ to $85^{\circ} \mathrm{C}$ |
| $\mathrm{V}_{\mathrm{OH}}$ | HV output when sourcing | 52 | - | V | $\mathrm{I}_{\mathrm{OH}}=-15 \mathrm{~mA},-55$ to $125^{\circ} \mathrm{C}$ |
| $\mathrm{V}_{\mathrm{oL}}$ | HV output when sinking | - | 8.0 | V | $\mathrm{I}_{\mathrm{OL}}=15 \mathrm{~mA},-55$ to $125^{\circ} \mathrm{C}$ |

## AC Characteristics

| Sym | Parameter | Min | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{f}_{\text {CLK }}$ | Clock frequency | - | 8.0 | MHz | --- |
| $\mathrm{t}_{\mathrm{WL}}$ or $\mathrm{t}_{\mathrm{WH}}$ | Clock width, HIGH or LOW | 62 | - | ns | --- |
| $\mathrm{t}_{\text {su }}$ | Setup time before CLK rises | 25 | - | ns | --- |
| $\mathrm{t}_{\mathrm{H}}$ | Hold time after CLK rises | 10 | - | ns | --- |
| $\mathrm{t}_{\text {DLH }}$ (data) | Data output delay after L to H CLK | - | 110 | ns | $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ |
| $\mathrm{t}_{\text {DHL }}$ (data) | Data output delay after H to L CLK | - | 110 | ns | $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ |
| $\mathrm{t}_{\text {DLE }}$ | $\overline{\text { LE }}$ delay after L to H CLK | 50 | - | ns | --- |
| $\mathrm{t}_{\text {WLE }}$ | Width of LE pulse | 50 | - | ns | --- |
| $\mathrm{t}_{\text {sLE }}$ | $\overline{\text { LE }}$ setup time before L to H CLK | 50 | - | ns | --- |
| $\mathrm{t}_{\text {ON }}$ | Delay from $\overline{L E}$ to $\mathrm{HV}_{\text {OUT }}$, L to H | - | 500 | ns | --- |
| $\mathrm{t}_{\text {OFF }}$ | Delay from $\overline{L E}$ to $\mathrm{HV}_{\text {OUt }}, \mathrm{H}$ to L | - | 500 | ns | --- |

## Switching Waveforms



## Input and Output Equivalent Circuits





Functional Block Diagram


Function Tables

| DATA INPUT | CLK* | DATA OUT | DATA INPUT | LE | OE | HV OUT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| H | $\stackrel{\square}{*}$ | H | X | X | L | All $\mathrm{HV}_{\text {OUt }}=$ LOW |
| L | $\stackrel{5}{1}$ | L | X | L | H | Previous latched data |
| X | No $\sim^{\sim}$ | No change | H | H | H | H |
| Note:$\text { * } \sqrt{ }=\text { LOW - to - HIGH transition }$ |  |  | L | H | H | L |
| $\begin{aligned} & H=\text { High } \\ & L=\text { Low } \\ & X=\text { Don't Care } \end{aligned}$ |  |  |  |  |  |  |

## 44-Lead PQFP Pin Assignment (PG)

| Pin | Function | Description |
| :---: | :---: | :---: |
| 1 | HV ${ }_{\text {Out }} 11$ | High voltage outputs. <br> High voltage push-pull outputs, which, depending on controlling low voltage data, can drive loads either to $G N D$, or to $\mathrm{V}_{\mathrm{Pp}}$ rail levels. |
| 2 | $\mathrm{HV}_{\text {OUT }} 12$ |  |
| 3 | $\mathrm{HV}_{\text {OUT }} 13$ |  |
| 4 | $\mathrm{HV}_{\text {OUT }} 14$ |  |
| 5 | $\mathrm{HV}_{\text {OUT }} 15$ |  |
| 6 | $\mathrm{HV}_{\text {OUT }}{ }^{16}$ |  |
| 7 | HV ${ }_{\text {Out }} 17$ |  |
| 8 | $\mathrm{HV}_{\text {OUT }} 18$ |  |
| 9 | $\mathrm{HV}_{\text {OUT }} 19$ |  |
| 10 | HV OUT ${ }^{20}$ |  |
| 11 | HV OUT 21 |  |
| 12 | $\mathrm{HV}_{\text {Out }} 22$ |  |
| 13 | $\mathrm{HV}_{\text {OUT }} 23$ |  |
| 14 | $\mathrm{HV}_{\text {out }} 24$ |  |
| 15 | $\mathrm{HV}_{\text {OUT }} 25$ |  |
| 16 | $\mathrm{HV}_{\text {OUT }}{ }^{26}$ |  |
| 17 | $\mathrm{HV}_{\text {OUT }} 27$ |  |
| 18 | $\mathrm{HV}_{\text {Out }} 28$ |  |
| 19 | $\mathrm{HV}_{\text {OUT }} 29$ |  |
| 20 | $\mathrm{HV}_{\text {OUT }} 30$ |  |
| 21 | $\mathrm{HV}_{\text {OUT }} 31$ |  |
| 22 | $\mathrm{HV}_{\text {OUT }} 32$ |  |
| 23 | DATA OUT | Serial data output. <br> Data output for cascading to the data input of the next device. |
| 24 | N/C | No connect. |
| 25 |  |  |
| 26 |  |  |
| 27 | CLK | Data shift register clock <br> Input are shifted into the shift register on the positive edge of the clock. |
| 28 | GND | Logic and high voltage ground. |
| 29 | VPP | High voltage power rail. |
| 30 | VDD | Low voltage logic power rail. |

## 44-Lead PQFP Pin Assignment (PG)

| Pin | Function | Description |
| :---: | :---: | :---: |
| 31 | $\overline{L E}$ | Latch enable input. <br> When $\overline{L E}$ is HIGH, shift register data is transferred into a data latch. When $\overline{L E}$ is LOW, data is latched, and new data can be clocked into the shift register. |
| 32 | DATA IN | Serial data input. <br> Data needs to be present before each rising edge of the clock. |
| 33 | OE | Output enable input. <br> When OE is LOW, all HV outputs are forced into a LOW state, regardless of data in each channel. When OE is HIGH, all HV outputs reflect data latched. |
| 34 | N/C | No connect. |
| 35 | $\mathrm{HV}_{\text {out }} 1$ | High voltage outputs. <br> High voltage push-pull outputs, which, depending on controlling low voltage data, can drive loads either to GND, or to $\mathrm{V}_{\mathrm{Pp}}$ rail levels. |
| 36 | $\mathrm{HV} \mathrm{out}^{2}$ |  |
| 37 | $\mathrm{HV}_{\text {OUT }}{ }^{3}$ |  |
| 38 | $\mathrm{HV}_{\text {OUT }} 4$ |  |
| 39 | $\mathrm{HV}_{\text {Out }}{ }^{5}$ |  |
| 40 | $\mathrm{HV}_{\text {OUT }}{ }^{6}$ |  |
| 41 | $\mathrm{HV}_{\text {OUT }} 7$ |  |
| 42 | $\mathrm{HV}_{\text {OUT }} 8$ |  |
| 43 | $\mathrm{HV}_{\text {OUT }} 9$ |  |
| 44 | HV out 10 |  |

## 44-Lead Quad Cerpac/PLCC Pin Assignment (DJ/PJ)

| Pin | Function | Description |
| :---: | :---: | :---: |
| 1 | $\mathrm{HV}_{\text {Out }} 16$ | High voltage outputs. <br> High voltage push-pull outputs, which, depending on controlling low voltage data, can drive loads either to GND, or to $\mathrm{V}_{\mathrm{PP}}$ rail levels. |
| 2 | $\mathrm{HV}_{\text {out }} 17$ |  |
| 3 | $\mathrm{HV}_{\text {Out }} 18$ |  |
| 4 | $\mathrm{HV}_{\text {Out }} 19$ |  |
| 5 | $\mathrm{HV}_{\text {Out }} 20$ |  |
| 6 | $\mathrm{HV}_{\text {Out }} 21$ |  |
| 7 | $\mathrm{HV}_{\text {out }} 22$ |  |
| 8 | $\mathrm{HV}_{\text {OUT }} 23$ |  |
| 9 | $\mathrm{HV}_{\text {OUT }} 24$ |  |
| 10 | $\mathrm{HV}_{\text {Out }} 25$ |  |
| 11 | $\mathrm{HV}_{\text {out }}{ }^{26}$ |  |
| 12 | $\mathrm{HV}_{\text {Out }} 27$ |  |
| 13 | $\mathrm{HV}_{\text {Out }}{ }^{28}$ |  |
| 14 | $\mathrm{HV}_{\text {Out }} 29$ |  |
| 15 | $\mathrm{HV}_{\text {OUT }} 30$ |  |
| 16 | $\mathrm{HV}_{\text {OUT }} 31$ |  |
| 17 | $\mathrm{HV}_{\text {OUT }} 32$ |  |
| 18 | DATA OUT | Serial data output. <br> Data output for cascading to the data input of the next device. |
| 19 | N/C | No connect. |
| 20 |  |  |
| 21 |  |  |
| 22 | CLK | Data shift register clock <br> Input are shifted into the shift register on the positive edge of the clock. |
| 23 | GND | Logic and high voltage ground. |
| 24 | VPP | High voltage power rail. |
| 25 | VDD | Low voltage logic power rail. |
| 26 | $\overline{L E}$ | Latch enable input. <br> When $\overline{L E}$ is HIGH, shift register data is transferred into a data latch. When $\overline{L E}$ is LOW, data is latched, and new data can be clocked into the shift register. |
| 27 | DATA IN | Serial data input. <br> Data needs to be present before each rising edge of the clock. |

## 44-Lead Quad Cerpac/PLCC Pin Assignment (DJ/PJ)

| Pin | Function | Description |
| :---: | :---: | :---: |
| 28 | OE | Output enable input. <br> When OE is LOW, all HV outputs are forced into a LOW state, regardless of data in each channel. When OE is HIGH, all HV outputs reflect data latched. |
| 29 | N/C | No connect. |
| 30 | HV ${ }_{\text {OUT }}{ }^{1}$ | High voltage outputs. <br> High voltage push-pull outputs, which, depending on controlling low voltage data, can drive loads either to GND, or to $\mathrm{V}_{\mathrm{PP}}$ rail levels. |
| 31 | $\mathrm{HV}_{\text {OUT }}{ }^{2}$ |  |
| 32 | $\mathrm{HV}_{\text {OUT }}{ }^{3}$ |  |
| 33 | $\mathrm{HV}_{\text {OUT }} 4$ |  |
| 34 | $\mathrm{HV}_{\text {OUT }}{ }^{5}$ |  |
| 35 | $\mathrm{HV}_{\text {OUT }} 6$ |  |
| 36 | $\mathrm{HV}_{\text {OUT }}{ }^{7}$ |  |
| 37 | $\mathrm{HV}_{\text {OUT }} 8$ |  |
| 38 | $\mathrm{HV}_{\text {OUT }} 9$ |  |
| 39 | $\mathrm{HV}_{\text {OUT }} 10$ |  |
| 40 | $\mathrm{HV}_{\text {Out }} 11$ |  |
| 41 | $\mathrm{HV}_{\text {OUT }} 12$ |  |
| 42 | $\mathrm{HV}_{\text {OUT }} 13$ |  |
| 43 | $\mathrm{HV}_{\text {OUT }} 14$ |  |
| 44 | $\mathrm{HV}_{\text {OUT }} 15$ |  |

## 44-Lead Quad Cerpac Package Outline (DJ)

 .650x.650in body, .190in height (max), .050in pitch

## Note:

1. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

| Symbol |  | A | A1 | A2 | b | b1 | D | D1 | E | E1 | e |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Dimension (inches) | MIN | . 155 | . 090 | $\begin{aligned} & .060 \\ & \text { REF } \end{aligned}$ | . 017 | . 026 | . 685 | . 630 | . 685 | . 630 | $\begin{aligned} & .050 \\ & \text { BSC } \end{aligned}$ |
|  | NOM | . 172 | . 100 |  | . 019 | . 029 | . 690 | . 650 | . 690 | . 650 |  |
|  | MAX | . 190 | . 120 |  | . 021 | . 032 | . 695 | . 665 | . 695 | . 665 |  |

JEDEC Registration MO-087, Variation AB, Issue B, August, 1991.
Drawings not to scale.
Supertex Doc. \#: DSPD-44CERPACDJ, Version D090808.

## 44-Lead PQFP Package Outline (PG)

## $10.00 \times 10.00 \mathrm{~mm}$ body, 2.35 mm height (max), 0.80 mm pitch



## Note:

1. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

| Symbol |  | A | A1 | A2 | b | D | D1 | E | E1 | e | L | L1 | L2 | $\theta$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Dimension (mm) | MIN | 1.95* | 0.00 | 1.95 | 0.30 | 13.65* | 9.80* | 13.65* | 9.80* | $\begin{aligned} & 0.80 \\ & \text { BSC } \end{aligned}$ | 0.73 | $\begin{aligned} & 1.95 \\ & \text { REF } \end{aligned}$ | $\begin{aligned} & 0.25 \\ & \text { BSC } \end{aligned}$ | $0^{\circ}$ |
|  | NOM | - | - | 2.00 | - | 13.90 | 10.00 | 13.90 | 10.00 |  | 0.88 |  |  | $3.5{ }^{\circ}$ |
|  | MAX | 2.35 | 0.25 | 2.10 | 0.45 | 14.15* | 10.20* | 14.15* | 10.20* |  | 1.03 |  |  | $7^{\circ}$ |

[^0]
## 44-Lead PLCC Package Outline (PJ) .653x.653in body, .180in height (max), .050in pitch



## Notes:

1. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.
2. Actual shape of this feature may vary.

| Symbol |  | A | A1 | A2 | b | b1 | D | D1 | E | E1 | e | R |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Dimension (inches) | MIN | . 165 | . 090 | . 062 | . 013 | . 026 | . 685 | . 650 | . 685 | . 650 | $\begin{aligned} & .050 \\ & \text { BSC } \end{aligned}$ | . 025 |
|  | NOM | . 172 | . 105 | - | - | - | . 690 | . 653 | . 690 | . 653 |  | . 035 |
|  | MAX | . 180 | . 120 | . 083 | . 021 | . $036{ }^{+}$ | . 695 | . 656 | . 695 | . 656 |  | . 045 |

[^1](The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to http://www. supertex.com/packaging.html.)

[^2]
[^0]:    JEDEC Registration MO-112, Variation AA-2, Issue B, Sep. 1995

    * This dimension is not specified in the JEDEC drawing.

    Drawings not to scale.
    Supertex Doc. \#: DSPD-44PQFPPG, Version C041309.

[^1]:    JEDEC Registration MS-018, Variation AC, Issue A, June, 1993.
    $\dagger$ This dimension differs from the JEDEC drawing.
    Drawings not to scale.
    Supertex Doc. \#: DSPD-44PLCCPJ, Version F031111.

[^2]:    Supertex inc. does not recommend the use of its products in life support applications, and will not knowingly sell them for use in such applications unless it receives an adequate "product liability indemnification insurance agreement." Supertex inc. does not assume responsibility for use of devices described, and limits its liability to the replacement of the devices determined defective due to workmanship. No responsibility is assumed for possible omissions and inaccuracies. Circuitry and specifications are subject to change without notice. For the latest product specifications refer to the Supertex inc. (website: http//www.supertex.com)

